



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

GAU 2811,
#3 Election
JTB
16-24-w

Re the Application of:

Theodore W. Houston

Docket No.: TI-21004

Serial No.: 09/346,436

Examiner: Hu, S.

Filed: 07/01/99

Art Unit: 2811

For: BONDED SOI WITH BURIED INTERCONNECT TO HANDLE
OR DEVICE WAFER

ELECTION

Assistant Commissioner for Patents

Washington, DC 20231

MAILING CERTIFICATE UNDER 37 C.F.R. § 1.8(A)
I hereby certify that the above correspondence is being deposited
with the U.S. Postal Service as first Class Mail in an envelope
addressed to Assistant Commissioner for Patents, Washington,
D.C. 20231 on:

June 15, 2000.

Marianna Smith
Marianna Smith

Dear Sir:

With respect to the Restriction Requirement mailed on 05/24/00, the Examiner has restricted the instant application to the invention of Group I (Claims 5-6 and 12-17), or Group II (Claims 1-4, 7-11 and 18-24). In light of this, Applicants elect to pursue Group II (Claims 1-4, 7-11 and 18-24) without traverse.

Respectfully submitted,

Jacqueline J. Garner
Attorney for Applicant(s)
Reg. No. 36,144

Texas Instruments Incorporated
P.O. Box 655474, M/S 3999
Dallas, TX 75265
(972) 271-1176 or
(972) 917-5643
Fax: (972) 917-4418

RECEIVED
JUN 22 2000
TECHNOLOGY CENTER 2800